

EAST Search History

Ref #	Hits	Search Query	Dbs	Default Operator	Purks	Time Stamp
L2	1	"5583780".pn	USPAT	OR	OFF	2006/03/21 17:05
L3	5	"10/673501" "10/673583" "10/673138" "10/673467" "10/673507"	US-PGPUB	OR	OFF	2006/03/21 17:07
L4	2	L3 and (rate).clm.	US-PGPUB	OR	OFF	2006/03/21 17:07
L5	19	(US-20030078738-\$ or US-20040078319-\$ or US-20040102934-\$ or US-20050016947-\$).did. or (US-5719796-\$ or US-6571371-\$ or US-6615097-\$ or US-6628809-\$ or US-6643616-\$ or US-6728591-\$ or US-6757645-\$ or US-6763277-\$ or US-6774998-\$ or US-6802045-\$ or US-6812045-\$ or US-6905895-\$).did. or (US-5866437-\$ or WO-200177979-\$ or WO-200277589-\$ or US-20030135302-\$ or US-20040078319-\$ or US-20050010319-\$).did.	US-PGPUB; USPAT	OR	OFF	2006/03/21 17:07
L6	19	(US-20030078738-\$ or US-20040078319-\$ or US-20040102934-\$ or US-20050016947-\$).did. or (US-5719796-\$ or US-6571371-\$ or US-6615097-\$ or US-6628809-\$ or US-6643616-\$ or US-6728591-\$ or US-6757645-\$ or US-6763277-\$ or US-6774998-\$ or US-6802045-\$ or US-6812045-\$ or US-6905895-\$).did. or (US-5866437-\$ or US-20030135302-\$ or US-20040078319-\$ or US-20050010319-\$).did.	US-PGPUB; USPAT	OR	OFF	2006/03/21 17:07
L7	8	L6 and rate	US-PGPUB; USPAT	OR	OFF	2006/03/21 17:07
L8	5	"10/673501" "10/673583" "10/673138" "10/673467" "10/673507"	US-PGPUB	OR	OFF	2006/03/21 17:07
L9	5	L8 and control\$6	US-PGPUB	OR	OFF	2006/03/21 17:07
L10	3	L8 and (control\$6).clm.	US-PGPUB	OR	OFF	2006/03/21 17:07
L11	2	L8 and (adjust\$6).clm.	US-PGPUB	OR	OFF	2006/03/21 17:07
L12	1	L8 and (nonlinear\$3 multivariate).clm.	US-PGPUB	OR	OFF	2006/03/21 17:07
L13	3	L5 and (nonlinear\$3 multivariate)	US-PGPUB	OR	OFF	2006/03/21 17:07
L14	1	L5 and (calibration)	US-PGPUB	OR	OFF	2006/03/21 17:07

EAST Search History

L15	9	L5 and (adjust)	US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/21 17:07
L16	3	L5 and (converg\$6)	US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/21 17:07
L17	4862	(ANST'S FLUENT CFD (Monte ad) Carto)) and simulat\$4	US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/21 17:07
L18	253	(ANST'S) and simulat\$4	US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/21 17:07
L19	3	(CFRDC) and simulat\$4	US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/21 17:07
L20	674	(FLUENT) and simulat\$4	US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/21 17:07
L21	1485	700/121.cds.	US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/21 17:07
L22	191	(FLUENT) with simulat\$4	US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/21 17:07

EAST Search History

L23	102	(ANSYS) with simulat\$4	US-PCPUB; USOCR; EPO; JPO; DERVENT; IBM_TDB	OR	ON	2006/03/21 17:07
L24	138	(FLUENT) and simulat\$4 and (semiconductor wafer)	US-PCPUB; USPAT; USOCR; EPO; JPO; DERVENT; IBM_TDB	OR	ON	2006/03/21 17:07
L25	5	"10/673501" "10/673583" "10/673138" "10/673467" "10/673507"	US-PCPUB; USPAT	OR	OFF	2006/03/21 17:07
L26	19	(US-20030078738-\$ or US-20040078319-\$ or US-20040102934-\$ or US-20050016947-\$).dtd, or (US-5719796-\$ or US-6571371-\$ or US-6615097-\$ or US-6628809-\$ or US-6643616-\$ or US-6728591-\$ or US-6757645-\$ or US-6763277-\$ or US-6774998-\$ or US-6802045-\$ or US-6812045-\$ or US-6905895-\$).dtd, or (US-5866437-\$ or US-20030135302-\$ or US-20040078319-\$ or US-20050010319-\$).dtd,	US-PCPUB; USPAT	OR	OFF	2006/03/21 17:07
L27	4	L26 and Geometric\$4	US-PCPUB; USPAT	OR	OFF	2006/03/21 17:07
L28	18542	(data parameter) with (etch deposition coating lithography (thermal adj annealing))	US-PCPUB; USPAT	OR	OFF	2006/03/21 17:07
L29	7445	L28 and (semiconductor wafer)	US-PCPUB; USPAT	OR	OFF	2006/03/21 17:07
L30	1316	L28 and geometric	US-PCPUB; USPAT	OR	OFF	2006/03/21 17:07
L31	23	geometric with (data parameter) with (etch deposition coating lithography (thermal adj annealing))	US-PCPUB; USPAT	OR	OFF	2006/03/21 17:07
L32	77	geometric and (data parameter) with (etch deposition coating lithography (thermal adj annealing)) with (semiconductor wafer)	US-PCPUB; USPAT	OR	OFF	2006/03/21 17:07
L33	2	(physical with geometric with parameters) with (data parameter) with (etch deposition coating lithography (thermal adj annealing))	US-PCPUB; USPAT	OR	OFF	2006/03/21 17:07

EAST Search History

L34	5	(geometric with parameters) with (data parameter) with (etch deposition coating lithography (thermal adj annealing))	US-PCPUB; USPAT	OR	OFF	2006/03/21 17:07
L35	2	(input with size) with (etch deposition coating lithography (thermal adj annealing)) with (semiconductor wafer)	US-PCPUB; USPAT	OR	OFF	2006/03/21 17:07
L36	5	"10/673501" "10/673583" "10/673138" "10/673467" "10/673507"	US-PCPUB; USPAT	OR	OFF	2006/03/21 17:07
L37	50	("5886906" "5886363" "6031246" "6049661" "6095161" "4268951" "4782253" "5004774" "5446742" "6030491" "6168891" "6178544" "6207630" "4343878" "4443532" "4481049" "4491530" "4500798" "4530587" "4564921" "4581706" "4582683" "4597985" "4602153" "4615782" "4769817" "4792893" "4801713" "4822716" "4842986" "4873661" "4952666" "4969748" "4984902" "4989166" "4999282" "5006717" "5017453" "5059516" "5198520" "5213996" "5243538" "5248956" "5288604" "5312723" "5312724" "5330884" "5331420" "5336752" "5339039").pdt,	USPAT	OR	OFF	2006/03/21 17:07
L38	50	("5340697" "5374327" "5382823" "5384289" "5400435" "5406309" "5405547" "5418397" "5427716" "5442644" "5455928" "5459020" "5474884" "5478702" "5490953" "5493501" "5495417" "5511005" "5517140" "5523022" "5558964" "5561612" "5571662" "5593608" "5596695" "5617322" "5619159" "5629877" "5637151" "5650947" "5654904" "5658706" "5663889" "5694325" "5694052" "5699264" "5706200" "5709757" "5712794" "5714678" "5715170" "5725974" "5728514" "5731626" "5736024" "5737242" "5745388").pdt,	USPAT	OR	OFF	2006/03/21 17:07
L39	6	(US-20050016947-\$).dtd, or (US-6625497-\$ or US-5629877-\$ or US-5377116-\$ or US-5719796-\$ or US-6802045-\$ or US-6812045-\$).dtd,	US-PCPUB; USPAT	OR	OFF	2006/03/21 17:07
L40	722	703/22.ccls,	US-PCPUB; USPAT	OR	OFF	2006/03/21 17:07